



N-Channel Super Junction Power MOSFET III

General Description

The series of devices use advanced trench gate super junction technology and design to provide excellent R_{DS(ON)} with low gate charge. This super junction MOSFET fits the industry's AC-DC SMPS requirements for PFC, AC/DC power conversion, and industrial power applications.

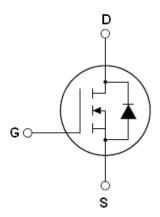
Features

- New technology for high voltage device
- Low on-resistance and low conduction losses
- Small package
- Ultra Low Gate Charge cause lower driving requirements
- 100% Avalanche Tested
- ROHS compliant

Application

- Power factor correction (PFC)
- Switched mode power supplies(SMPS)
- Uninterruptible Power Supply (UPS)

V_{DS}	700	V
R _{DS(ON)TYP}	820	mΩ
In	5	A



Schematic diagram

Package Marking And Ordering Information

Device	Device Package	Marking
NCE70T900I	TO-251	NCE70T900I
NCE70T900K	TO-252	NCE70T900K





TO-251

TO-252

Table 1. Absolute Maximum Ratings (T_c=25℃)

Parameter	Symbol	Value	Unit
Drain-Source Voltage (Vgs=0V)	V _{DS}	700	V
Gate-Source Voltage (VDS=0V) ,AC (f>1 Hz)	V _{GS}	±30	V
Continuous Drain Current at Tc=25°C	I _{D (DC)}	5	Α
Continuous Drain Current at Tc=100°C	I _{D (DC)}	3	Α
Pulsed drain current (Note 1)	I _{DM (pluse)}	20	Α
Maximum Power Dissipation(Tc=25℃)	P _D	46	W
Derate above 25°C		0.37	W/°C
Single pulse avalanche energy (Note2)	Eas	52	mJ
Avalanche current ^(Note 1)	I _{AR}	0.9	Α
Repetitive Avalanche energy , t_{AR} limited by T_{jmax} (Note 1)	E _{AR}	0.14	mJ



Parameter	Symbol	Value	Unit
Drain Source voltage slope, V _{DS} ≤480 V,	dv/dt	50	V/ns
Reverse diode dv/dt, $V_{DS} \leq 480 \text{ V}, I_{SD} < I_{D}$	dv/dt	15	V/ns
Operating Junction and Storage Temperature Range	T_J, T_{STG}	-55+150	°C

Table 2. Thermal Characteristic

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case (Maximum)	R _{thJC}	2.72	°C /W
Thermal Resistance, Junction-to-Ambient (Maximum)	R _{thJA}	75	°C /W

Table 3. Electrical Characteristics (TA=25 ℃ unless otherwise noted)

Parameter	Symbol Condition		Min	Тур	Max	Unit
On/off states			1			<u>L</u>
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA	700			V
Zero Gate Voltage Drain Current(Tc=25℃)	I _{DSS}	V _{DS} =700V,V _{GS} =0V			1	μA
Zero Gate Voltage Drain Current(Tc=125℃)	I _{DSS}	V _{DS} =700V,V _{GS} =0V			50	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V			±100	nA
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =250µA	3		4	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =2.5A		820	950	mΩ
Dynamic Characteristics						
Input Capacitance	C _{lss}	V -50V/V -0V/		370		pF
Output Capacitance	C _{oss}	V_{DS} =50V, V_{GS} =0V, F=1.0MHz		25		pF
Reverse Transfer Capacitance	C _{rss}	F=1.UIVID2		0.5		pF
Total Gate Charge	Q_g	\/ -400\/ -54		10.5	15	nC
Gate-Source Charge	Q_{gs}	V _{DS} =480V,I _D =5A,		2.6		nC
Gate-Drain Charge	Q_{gd}	- V _{GS} =10V		5.3		nC
Switching times						
Turn-on Delay Time	t _{d(on)}			8		nS
Turn-on Rise Time	t _r	V _{DD} =420V,I _D =3A,		4		nS
Turn-Off Delay Time	t _{d(off)}	$R_G=5\Omega, V_{GS}=10V$		55		nS
Turn-Off Fall Time	t _f			11		nS
Source- Drain Diode Characteristics						
Source-drain current(Body Diode)	I _{SD}	T -25°C			5	Α
Pulsed Source-drain current(Body Diode)	I _{SDM}	- T _C =25°C			20	Α
Forward on voltage	V_{SD}	Tj=25°C,I _{SD} =5A,V _{GS} =0V		0.9	1.2	V
Reverse Recovery Time	t _{rr}			210		nS
Reverse Recovery Charge	Q _{rr}	Tj=25°C,I _F =2.5A,di/dt=100A/μs		0.66		uC
Peak reverse recovery current	I _{rrm}			6.5		Α

Notes: 1.Repetitive Rating: Pulse width limited by maximum junction temperature

2. Tj=25°C,VDD=50V,VG=10V, R_G=25 Ω

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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (curves)

Figure 1. Safe operating area

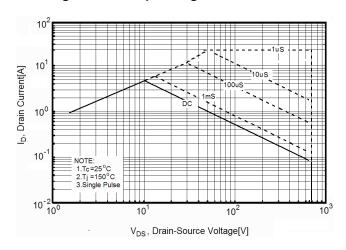


Figure 3. Output characteristics

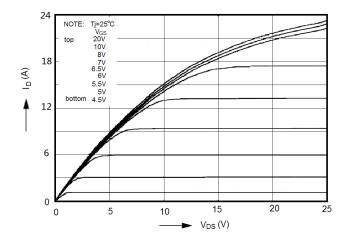


Figure 5. Static drain-source on resistance

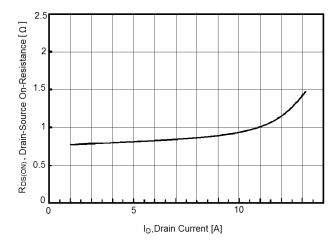


Figure 2. Source-Drain Diode Forward Voltage

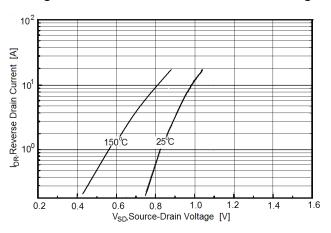


Figure 4. Transfer characteristics

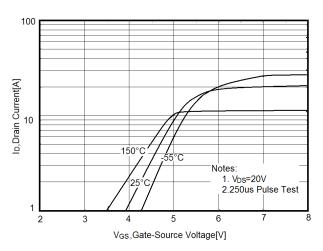
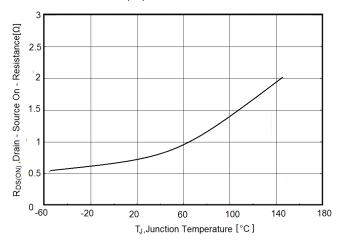


Figure 6. R_{DS(ON)} vs Junction Temperature



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Figure 7. BV_{DSS} vs Junction Temperature

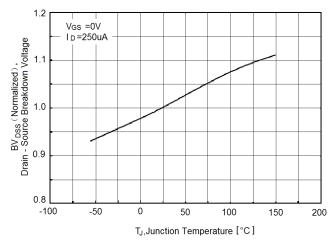


Figure 9. Gate charge waveforms

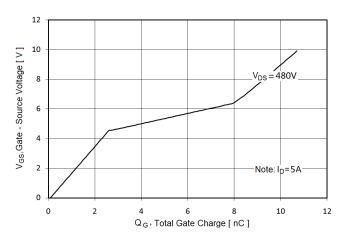


Figure 11. Transient Thermal Impedance

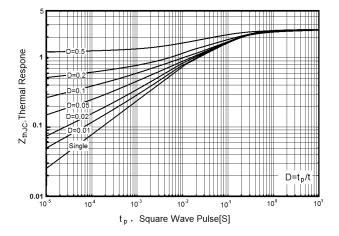


Figure 8. Maximum I_D vs Junction Temperature

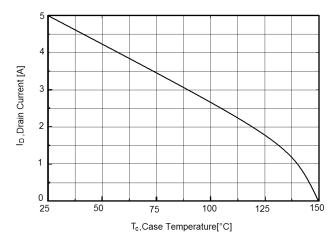
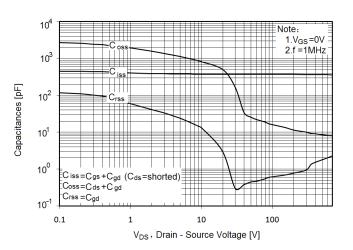


Figure 10. Capacitance



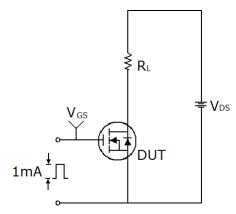
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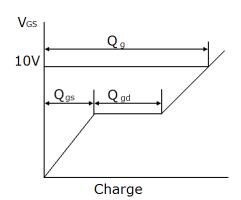
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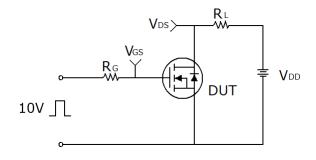
Test circuit

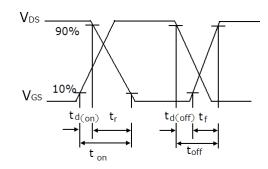
1) Gate charge test circuit & Waveform



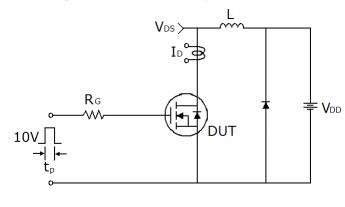


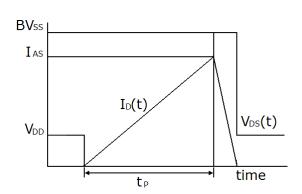
2) Switch Time Test Circuit:





3) Unclamped Inductive Switching Test Circuit & Waveforms

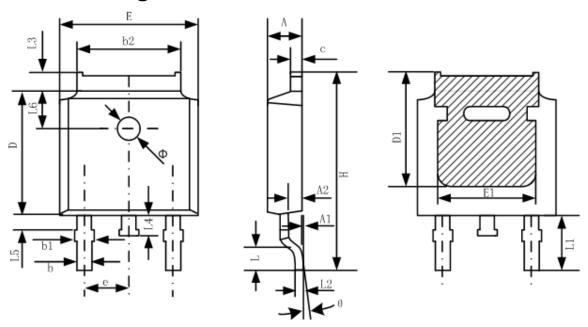




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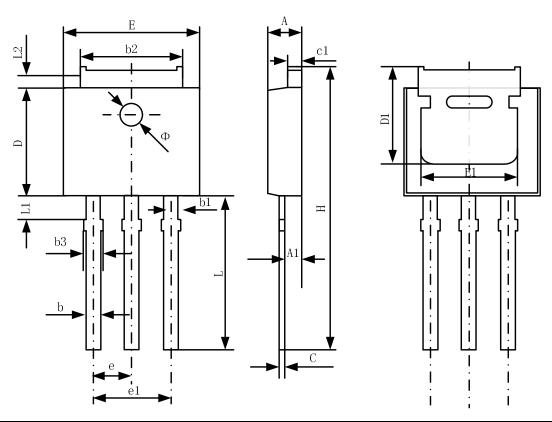
TO-252-2 Package Information



Symbol	Dimension	s In Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
Α	2.20	2.38	0.087	0.094	
A1	0.00	0.10	0.000	0.004	
A2	0.90	1.10	0.035	0.043	
b	0.72	0.85	0.028	0.033	
b1	0.72	0.90	0.028	0.035	
b2	5.13	5.46	0.202	0.215	
С	0.47	0.60	0.019	0.024	
D	6.00	6.20	0.236	0.244	
D1	5.25		0.207		
E	6.50	6.70	0.256	0.264	
E1	4.70		0.185		
e	2.19	2.39	0.086	0.094	
Н	9.80	10.40	0.386	0.409	
L	1.40	1.70	0.055	0.067	
L1	2.9	90 REF	0.114 REF		
L2	0.5	08 BSC	0.020 BSC		
L3	0.90	1.25	0.035	0.049	
L4	0.60	1.00	0.024	0.039	
L5	0.15	0.75	0.006	0.030	
L6	1.80 REF		0.071 REF		
Ф	1.20	1.40	0.047	0.055	
θ	0°	8°	0°	8°	



TO-251 Package Information



Symbol	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
A	2.20	2.35	0.087	0.093	
A1	0.90	1.10	0.035	0.043	
b	0.56	0.69	0.022	0.027	
b1	0.77	0.90	0.030	0.035	
b2	5.23	5.43	0.206	0.214	
b3		1.05	0.000	0.041	
С	0.46	0.59	0.018	0.023	
c1	0.46	0.59	0.018	0.023	
D	6.00	6.20	0.236	0.244	
D1	5.20		0.205		
E	6.50	6.70	0.256	0.264	
E1	4.60	5.00	0.181		
e	2.24	2.34	0.088	0.092	
e1	4.47	4.67	0.176	0.184	
Н	16.18	16.78	0.637	0.661	
L	9.00	9.60	0.354	0.378	
L1	0.95	1.35	0.037	0.053	
L2	0.90	1.25	0.035	0.049	



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